

2024 IEEE Workshop on Microelectronics and Electron Devices (WMED 2024)

**Boise, Idaho, USA
29 March 2024**



**IEEE Catalog Number: CFP24564-POD
ISBN: 979-8-3503-9595-2**

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IEEE Catalog Number:	CFP24564-POD
ISBN (Print-On-Demand):	979-8-3503-9595-2
ISBN (Online):	979-8-3503-9594-5
ISSN:	1947-3834

Additional Copies of This Publication Are Available From:

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